



PRODUCT INFORMATION

	PART #	CEPF286H127-130-12-30P30R	Revision	3-2016
Piezoelectric Self-Resonating Sound Transducer				

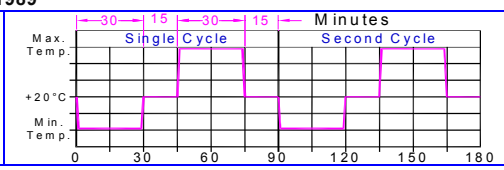
DESCRIPTION	FEATURES	
Challenge Electronics Piezoelectric Feedback Transducer; 28.6 mm Diameter; H style case (Round with PC Pins Standoffs); 12.7 mm High, 1-30 Vp-p; Nominal Voltage 12 Vp-p; 3,000 Hz. Operating Frequency; Sound Pressure Level Minimum 83 dB(A) with test circuit (page # 2), 30 cm, 12 Vdc; PC Pins, 30 mm diameter	<ul style="list-style-type: none"> ◆ Extended Temperatures ◆ RoHS Compliant ◆ ISO 9001 Certified 	

REACH COMPLIANCE DECLARATION
This Article contains Piezoelectric-Ceramic-Disc, which is more than 0.1% (w/w) of REACH Candidate List SVHC Lead-Zirconium-Titanium-Oxide (CAS 12626-81-2), a key ingredient of the Piezoelectric-Ceramic-Disc in the Alarm operation. See section Substance Of Very High Concern and RoHS Lead Free Compliance, page # 3, for full details.

SPECIFICATIONS

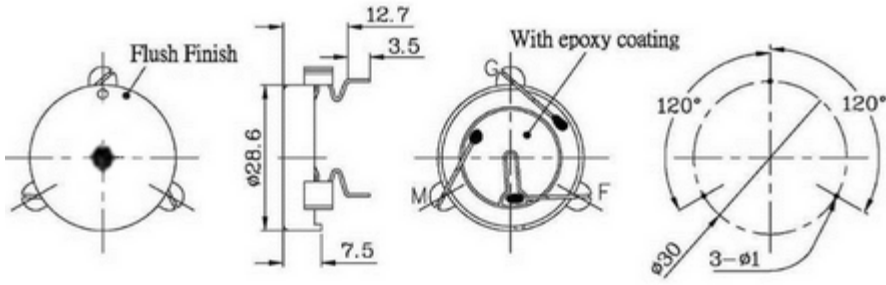
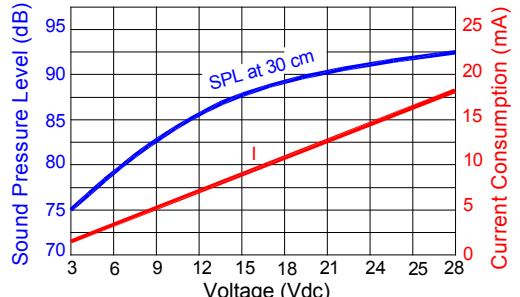
Operating Voltage	1 to 30 Vp-p	Nominal Operating Voltage	12 Vp-p	Operating Frequency	3,000 ± 500 Hz. mounted in case			
Resonant Frequency (Fo)	Piezo 3,700 ± 500 Hz.	Capacitance	20,000 ± 30% pF, at 120 Hz. 1 VRMS	Resonant Impedance	Maximum 400 Ω			
Sound Pressure Level	Minimum 83 dB(A)	SPL is measured at: with test circuit (page # 2), 12 Vdc, 30 cm, 25°C, Sound Level meter # 2240, Type 2, Fast Response, A-Weighted; per SJ/T10382-1993						
Maximum Current	8 mA, with test circuit (page # 2), 12 Vdc							
Operating Temperature	-30°C to +85°C	Storage Temperature	-40°C to +95°C					
Materials	Housing	ABS, UL-94 1/16" HB, High Heat, Black		Sound Port	Top			
	Diaphragm	Brass		Encapsulation	None			
	Termination	Three (3) PC Pins, Brass, Au Plated, 3.5 ± 0.5 mm Long						
Physical Dimensions	Diameter (D)	28.6 mm Ø	Height (H)	12.7 mm	PC Pins Spacing	30.0 mm Ø, at 120°	PC Pin Diameter	1.0 mm Ø
Approximate Weight	3.8 grams	Removable Washing Label	No	Compliance	RoHS, SVHC, and REACH			
Options								

RELIABILITY	1. Reliability Tests done per Buzzer test method SJ-258-10382 2. * Parts should conform to original performance within ±3dB, after 3 hours of recovery and dry period	
Thermal Operating Temperature Test	96 hours continuous operation at Nominal Voltage, at Maximum Operating Temperature, per GB/T2423.2-1989 *	
Thermal Storage Temperature Test	96 hours continuous operation at Nominal Voltage, at Minimum Operating Temperature; per GB/T2423.1-1989 *	
Thermal Shock Test	5 cycles of Minimum and Maximum Operating Temperature	
	Each cycle shall be set per diagram below and is three (3) hours long. Make sure to limit temperature range to specifications listed above, per GB/T2423.3-1993 *	
Humidity Test	120 Hours at +60°C±2°C, 90-95% RH, per EIA/JESD22 – A101 & GB2423.3-93 *	
Vibration Test	2 Hours at 1.5 mm with 10 to 55 Hz. of vibration frequency to each of 3 perpendicular direction *	
Drop Test	Dropped naturally from 1 meter height onto the surface of 10 mm wooden board, 2 directions upper and side of the part are applied, per GB2423.8-81 *	
Termination Strength	Maximum of 15 pounds (6.8 Kg) load pull test.	
Solderability	Withstand Wave or Drag-Soldering at maximum of 260°C or Manual Soldering at maximum of 240°C for 3 seconds	
Life Test	Intermittent	1,000 hours of a 1 minute on 4 minutes off cycle at room temperature and maximum Voltage
	Continuous	250 hours continuous operation at room temperature and maximum Voltage
Warranty	For a period of One (1) year from date of shipping under normal operations conditions This warranty does not apply to products damaged through misuse, abuse, improper installation, alteration, rework, or attempt to repair	

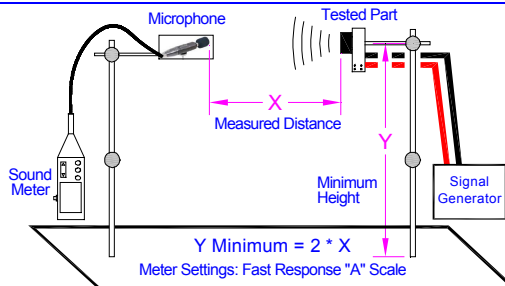




DIMENSIONS	Units	Inches	Tolerance	0.030	PERFORMANE USING TEST CIRCUIT
		(mm)		(0.7)	

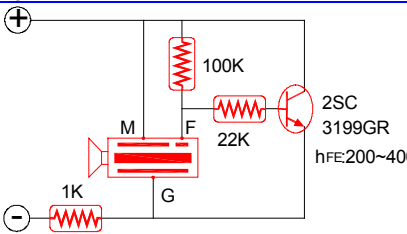
Standard SPL Measurement Process



X = 11.8" (30 cm)

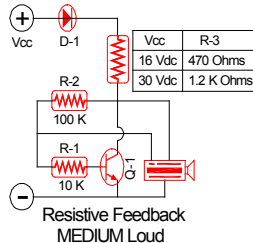
TEST CIRCUIT

Sound Type: Continuous Tone
 Input Power: 12 Vdc

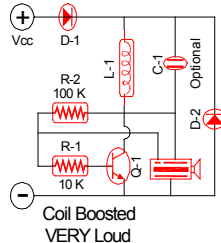


DRIVING CIRCUIT APPLICATIONS

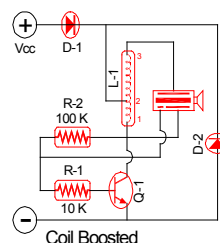
FEEDBACK DRIVE CIRCUITS



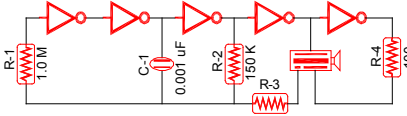
Resistive Feedback
MEDIUM Loud



Coil Boosted
VERY Loud



Coil Boosted
ULTRA Loud



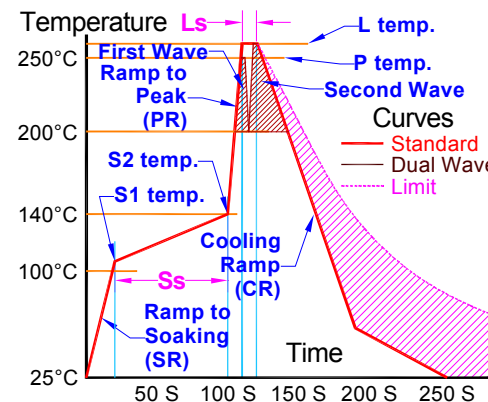
CD-4049, CMOS Voltage Doubler, LOUD

PIEZOELECTRIC PRECAUTION

- Do not maintain Vdc (Direct Current) on the Piezoelectric Assembly. Direct Voltage may depolarize the Piezoelectric Ceramic Disc resulting in Lower Sound Pressure Levels
- A non-polarize Capacitor can be used in series with the Piezoelectric Sound Transducer to block constant Vdc
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RECOMMENDED WAVE SOLDER TEMPERATURE PROFILE

Below is a standard temperature profile for Through Hole Devices according to JESD22-B106 and IEC668 2-20 (260°C, 10 s)



Profile Feature	Symbol	Recommended Setting
Ramp to Soaking	(SR)	3°C/S max
Preheat and Soaking Temperature	(S1 temp.)	110°C
Preheat and Soaking Temperature	(S2 temp.)	150°C
Preheat and Soaking Time	(Ss)	60 S to 120 S
Ramp to Peak Temperature	(PR)	1-2°C/S
Peak Temperature	(P temp.)	217°C
Limit Temperature	(L temp.)	260°C
Maximum Soldering Time	(Ls)	45 S to 75 S
Cooling Ramp	(CR)	2-4°C/S



SUBSTANCE OF VERY HIGH CONCERN and RoHS COMPLIANCE DECLARATION

This product does NOT contain any of the REACH Substances of Very High Concern (SVHC), and complies with European Union REACH Regulation No.1907/2006 regarding chemical substances that must be registered and disclosed with one (1) Exemption

Lead (Pb) / Lead Compounds	≤1,000 ppm	≤ 10,000 ppm ⁽¹⁾	Poly Brominated Diphenyl Ethers (PBDE)	≤1,000 ppm	In compliance
Mercury (Hg) / Mercury Compounds	≤1,000 ppm	In compliance	Bis (2-Ethylhexyl) Phthalate (DEHP)	≤1,000 ppm	In compliance
Cadmium (Cd) / Cadmium Compounds	≤ 100 ppm	In compliance	Butyl Benzyl Phthalate (BBP)	≤1,000 ppm	In compliance
Hexavalent Chromium (Cr vi)	≤1,000 ppm	In compliance	Dibutyl Phthalate (DBP)	≤1,000 ppm	In compliance

(1) European Union Directive 2011/65/EU (RoHS Directive) of the European Parliament. And of the Council of 8 June 2011 and all subsequent amendments, The ANNEX III of the Directive Applications exempted from the restriction in Article 4(1): 7(c)-I, Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. Piezoelectric devices, or in a glass or ceramic matrix compound Piezoelectric is also known as Lead Zirconate Titanate (PZT) ceramics. Piezoelectric Ceramic disc, (PZT), lead as high covalent compound in the ceramic matrix to achieve good ferroelectric properties in a wide temperature range. The best-known performances can be reached with PZT ceramics, which are a mixture of PbTiO₃ and PbZrO₃. The lead content, homogeneous material compound is between 58% and 68% by weight depending on the proportion of zirconium (Zr) and titanium (Ti)

- 1) According to the REACH terminology, Challenge Electronics acknowledge being Producers, Importers and Marketer of Sound Devices Articles, which do not contain Substances of Very High Concern (SVHC's) to be intentionally released
- 2) Challenge Electronics hereby declares, to the best of our knowledge and based on our China Manufacturers and Fabricators information, that, all Challenge Electronics Sound Devices Articles are chemically safe, and should not harm any human, animals, or the environment
- 3) It should be noted that SVHC items are not banned from inclusion, but are Reportable per current REACH regulations
 - a) With the exception of The Piezoelectric-Ceramic-Disc article that CONTAINS more than 0.1% (w/w) of REACH Candidate List SVHC Lead-Zirconium-Titanium-Oxide (CAS 12626-81-2), which is a key ingredient of the Piezoelectric-Ceramic-Disc in the Alarm operation. See also the RoHS Compliance ANNEX III of the Directive Applications exempted from the restriction in Article 4(1)
 - b) Some SMD and Dip type Capacitors CONTAINS one of the following Lead Oxides published in the ECHA SVHC Candidate List at or greater than 0.1% of total weight: Lead monoxide (CAS 1317-36-8), Lead titanium zirconium oxide (CAS 12626-81-2)

IMDS Guide for Piezoelectric

Automotive Industry Interpretation Guide for ELV Annex II (2016/774/EU) with IMDS Information added by the IMDS Steering Committee

- Interpretation Guide for ELV Annex II (2016/774/EC) Version 3.0
- Definition/interpretation of -Exemption (10a)

Examples for components covered by (10a)

a) Piezoceramics
Piezoceramics are characterized through their ability to transform mechanical energy in electrical energy and reciprocal. They fulfil technical functions as actuators, sensors, generators and motors. They are used for instance in Actuators for diesel and gasoline injection valves, knock sensors, resonator and filter, actuators, bending actuators for pneumatic valves, tire Pressure Sensors, ceramic sensors (like ABS, air bag, pressure, car navigation sensors), **Piezoelectric Alarms, Piezoelectric buzzers, Piezoelectric Sound Transducers, Ultrasonic Sensor and Transmitter.** The lead content in the Piezoceramics ceramics is around 50 to 70% by weight, depending on the content of dopants, required functional properties and on the proportion of Zirconium (Zr) and Titanium (Ti)

Lead Zirconium Titanium Oxide Information Basic information

Density:	7.7 g/cm ³	CAS #:	12626-81-2	EC #:	235-727-4	Inclusion Date:	12/19/2012	DN:	ED/169/2012	Product Categories:	Inorganics
Safety Information:	RIDADR:	UN1993	TSCA:	Yes	Hazard Class:	3	Packing Group:	III			

In Challenge Electronics role as Supplier, we have taken the necessary steps towards our China Manufacturing in order to get a written confirmation about their knowledge of the Regulation and their analysis of the impact on their company

PACKAGING

MARKING Shipping Box		TRAY	
Part Number	Dimensions	X1	9 cm
Customer PN (if required)		Y1	8 cm
Quantity		Z1	8 cm
Lot and / or Date Code	Quantity	160	
SHIPPING BOX			
PO Number	Dimensions	X3	55 cm
Net Weight		Y3	33 cm
Gross Weight		Z3	29 cm
Box Number _ of _ Boxes	Quantity	1,600	
RoHS	Approximate Weight		
	Volume	0.053 m ³	
	Made in	China	

Revision	Description	By	Date
1-2013	Updated Specifications	E. Zofan	12/19/2013
2-2016	Added Capacitance Data and REACH Declaration	E. Zofan	8/24/2016
3-2016	Clarified the information of SUBSTANCE OF VERY HIGH CONCERN and RoHS COMPLIANCE DECLARATION	E. Zofan	11/8/2016